

March 25<sup>th</sup>, 2025  
Tokyo Seimitsu Co., Ltd.

### Notice on Personnel Changes

Tokyo Seimitsu Co., Ltd. (the Company) announces personnel changes as follows.

Personnel changes (effective from April 1<sup>st</sup>, 2025)

Name	New	Current
HOKIDA Takahiro	Director Head of Semiconductor Company General Manger, IT Dept, Administration Company General Manager, Business Strategy Dept. (Promoted)	Director Managing Executive Officer, Semiconductor Company General Manager, Technology Division Group Leader, Prober System Group General Manger, IT Dept., Administration Company
ISHIKAWA Kazumasa	Executive Officer Head of Metrology Company (Promoted)	Appointive Executive Officer to the Head of Metrology Company
KATO Asashi	Executive Officer Head of Administration Company (Promoted)	Managing Executive Officer, Administration Company General Manager, Human Resources Dept. General Manager, Public Relations Dept. General Manager, Audit Dept.
KUBO Yuichi	Managing Executive Officer, Semiconductor Company General Manager, Technology Division General Manager, Application Center Team Leader, Product Sales Team	Managing Executive Officer, Semiconductor Company General Manager, Back-end Process Technology Dept., Technology Division Group Leader, Dicer System Group General Manager, Application Center Team Leader, Product Sales Team
IDE Ryoichi	Managing Executive Officer, Semiconductor Company General Manager, Sales Division (Promoted)	Executive Officer, Semiconductor Company General Manager, International Sales and Marketing Dept., Sales Division Section Manager, International Sales I
AKADA Koji	Executive Officer, Semiconductor Company Deputy General Manager, Production Headquarter	Deputy General Manager, Production Headquarter, Semiconductor Company Plant Manager of <i>Hanno</i> Plant General Manager, Manufacturing Dept.,

	Plant Manager, <i>Hanno</i> Plant General Manager, Manufacturing Dept. IT Strategy Team, IT Dept., Administration Company (Promoted)	IT Strategy Team, IT Dept., Administration Company
SAKATA Ryo	Executive Officer, Semiconductor Company General Manager, International Sales and Marketing Dept., Sales Division Team Leader, International Sales I Team Leader, China Team (Promoted)	Team Leader, China Team, International Sales I of International Sales and Marketing Dept., Sales Division, Semiconductor Company
KIKUTA Tetsuya	Executive Officer, Metrology Company Plant Manager, <i>Tsuchiura</i> Plant Deputy Manager, Production Control Dept. Team Leader, Planning Management Team Metrology Business Development Division (Promoted)	General Manager, Manufacturing Dept., <i>Tsuchiura</i> Plant, Metrology Company Deputy Manager, Production Control Dept. Team Leader, Planning Management Team
TOGAWA Yoichi	Executive Officer, Metrology Company Group Leader, Coordinate Measuring Group, Technology Division Metrology Business Development Division, Business Strategy Dept. (Promoted)	Group Leader, Coordinate Measuring Group, Technology Division, Metrology Company
MASUTA Hikaru	Executive Officer, Metrology Company Group Leader, Surface Form & Gauge Group, Technology Division, Metrology Business Development Division, Business Strategy Dept. (Promoted)	Group Leader, Surface & Form Group, Technology Division, Metrology Company
INOSE Tomoko	Executive Officer, Administration Company General Manager, Export Operation Dept. (Promoted)	General Manager, Export Operation Dept., Administration Company
KAMADA Shinji	Group Leader, Dicer System Group, Technology Division, Semiconductor Company	Appointive to Semiconductor Company, Accretech America Inc. (stationed)

	Business Strategy Dept. (Promoted)	
IGUCHI Yasuhito	Group Leader, Prober System Group, Technology Division, Semiconductor Company Business Strategy Dept. (Promoted)	A Team , Prober System Group, Test Technology Dept., Technology Division, Semiconductor Company
OKUBO Nobuhiro	General Manager, Manufacturing Dept., <i>Tsuchiura</i> Plant, Metrology Company Team Leader, SFG Team, Team Leader, Production Technology Team (Promoted)	Team Leader, SFG Team, Manufacturing Dept., <i>Tsuchiura</i> Plant, Metrology Company Team Leader, Production Technology Team
MORII Hideki	General Manager, Development Dept., Technology Division, Metrology Company Metrology Business Development Div., (Promoted)	Deputy Leader, Surface & Form Group, Technology Division, Metrology Company Deputy Leader, Development Team
FUJII Shogo	General Manager, Japan Sales Dept. IV, Japan Sales, Sales Division, Metrology Company General Manager, <i>Kyushu</i> Office (Promoted)	General Manager, <i>Kyushu</i> Office, Japan Sales Dept. IV, Japan Sales, Sales Division, Metrology Company

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